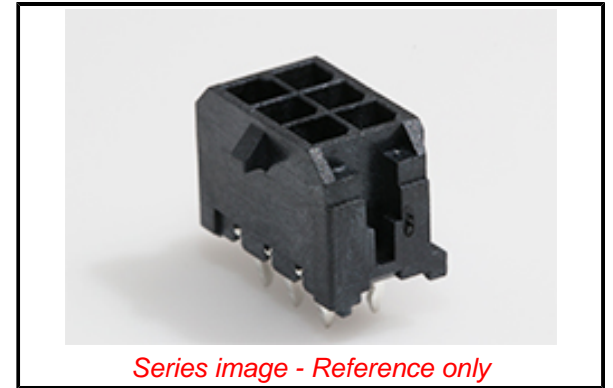


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Part Number: [0430450614](#)
Status: **Active**
Overview: [Micro-Fit Connector System](#)
Description: Micro-Fit 3.0 Vertical Header, 3.00mm Pitch, Dual Row, 6 Circuits, with PCB Polarizing Peg, Gold, Glow-Wire Capable, Black

Documents:

3D Model	Test Summary TS-43045-002-001 (PDF)
Drawing (PDF)	Test Summary TS-46235-001-001 (PDF)
Packaging Specification PK-70873-0314-001 (PDF)	RoHS Certificate of Compliance (PDF)
Test Summary TS-43045-001-001 (PDF)	Product Literature (PDF)



Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	PCB Headers
Series	43045
3D Viewer	Yes
Application	Power, Wire-to-Board
CURRENT-MAX-NUMERIC	8.5
Comments	<p>High Temperature Square Pin Offset Through Hole Mounting Solder Type<P><P>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13.. b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <P><P> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard IEC 60695-2-11 and any applicable product end-use standard(s). <P> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options. High Temperature Square Pin Offset Through Hole Mounting Solder Type<P><P>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13.. b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <P><P> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard</p>

EU ELV

Not Relevant

EU RoHS

Compliant

REACH SVHC

Not Contained Per

-ED/88/2018 (15

January 2019)

Halogen-Free

Status

Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

ELV

RoHS Phthalates

China RoHS

Green Image

Not Relevant

Not Contained

Search Parts in this Series

[43045 Series](#)

Mates With

Micro-Fit 3.0 Receptacle Housing [43025](#)

Micro-Fit 3.0 TPA Receptacle Housing

[172952](#)

IEC 60695-2-11 and any applicable product end-use standard(s). <P> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options. """"""""
Micro-Fit Connector System
 3.00
 987650-5984
 Micro-Fit 3.0
 800754371254

Overview

PITCH-MATING-NUMERIC
 Product Literature Order No
 Product Name
 UPC

Physical
 Breakaway No
 Circuits (Loaded) 6
 Circuits (maximum) 6
 Color - Resin Black
 Durability (mating cycles max) 30
 Flammability 94V-0
 Glow-Wire Capable Yes
 Mated Height 17.64mm
 Material - Metal Brass
 Material - Plating Mating Gold
 Material - Plating Termination Tin
 Material - Resin High Temperature Thermoplastic
 Net Weight 0.974/g
 Number of Rows 2
 Orientation Vertical
 PCB Locator Yes
 PCB Retention Yes
 PCB Thickness - Recommended 1.60mm
 Packaging Type Tray
 Pitch - Mating Interface 3.00mm
 Plating min - Mating 0.762µm
 Polarized to PCB Yes
 Shrouded Fully
 Stackable No
 Surface Mount Compatible (SMC) Yes
 Temperature Range - Operating -40° to +105°C
 Termination Interface: Style Through Hole - Kinked Pin

Electrical

Current - Maximum per Contact 8.5A
 Voltage - Maximum 600V

Solder Process Data

Duration at Max. Process Temperature (seconds) 030
 Lead-freeProcess Capability SMC&WAVE
 Max. Cycles at Max. Process Temperature 003
 Process Temperature max. C 260

Material Info

Reference - Drawing Numbers

Packaging Specification PK-70873-0314-001
 Sales Drawing SD-43045-005
 Symbol/Footprint Data SYM-43045-0612, SYM-43045-061X
 Test Summary TS-43045-001-001, TS-43045-002-001, TS-46235-001-001